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SciVal 主题

摘要

The proceedings contain 118 papers. The topics discussed include: RCS reduction based on optimization algorithms and novel polarization conversion meta-surface; using UDP to realize flexible and portable human activity recognition; research on temperature compensation algorithm based on optical fiber inertia combination; advancements in video tracking technology: a deep learning approach with SiamMask; positioning method for covered vehicles based on neutrino detection and reinforcement learning; privacy-preserving data splitting based on machine learning; enhanced lightweight hazardous waste detection algorithm of YOLOv5s; research on the application of intelligent 5G network slicing technology; and a boiler heating surface overtemperature warning method based on multi source data fusion and neural network model.

SciVal 主题 ⓘ

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